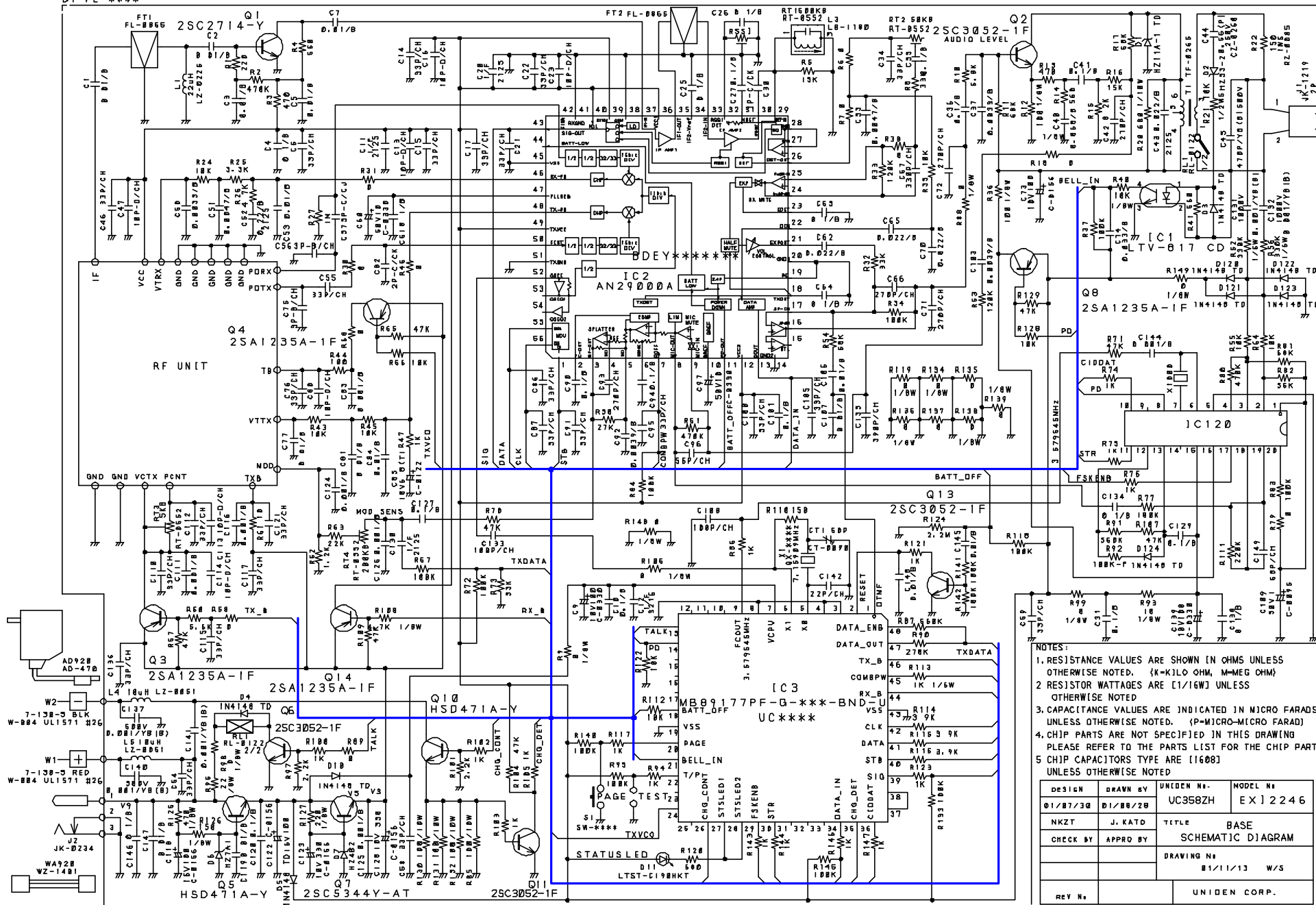
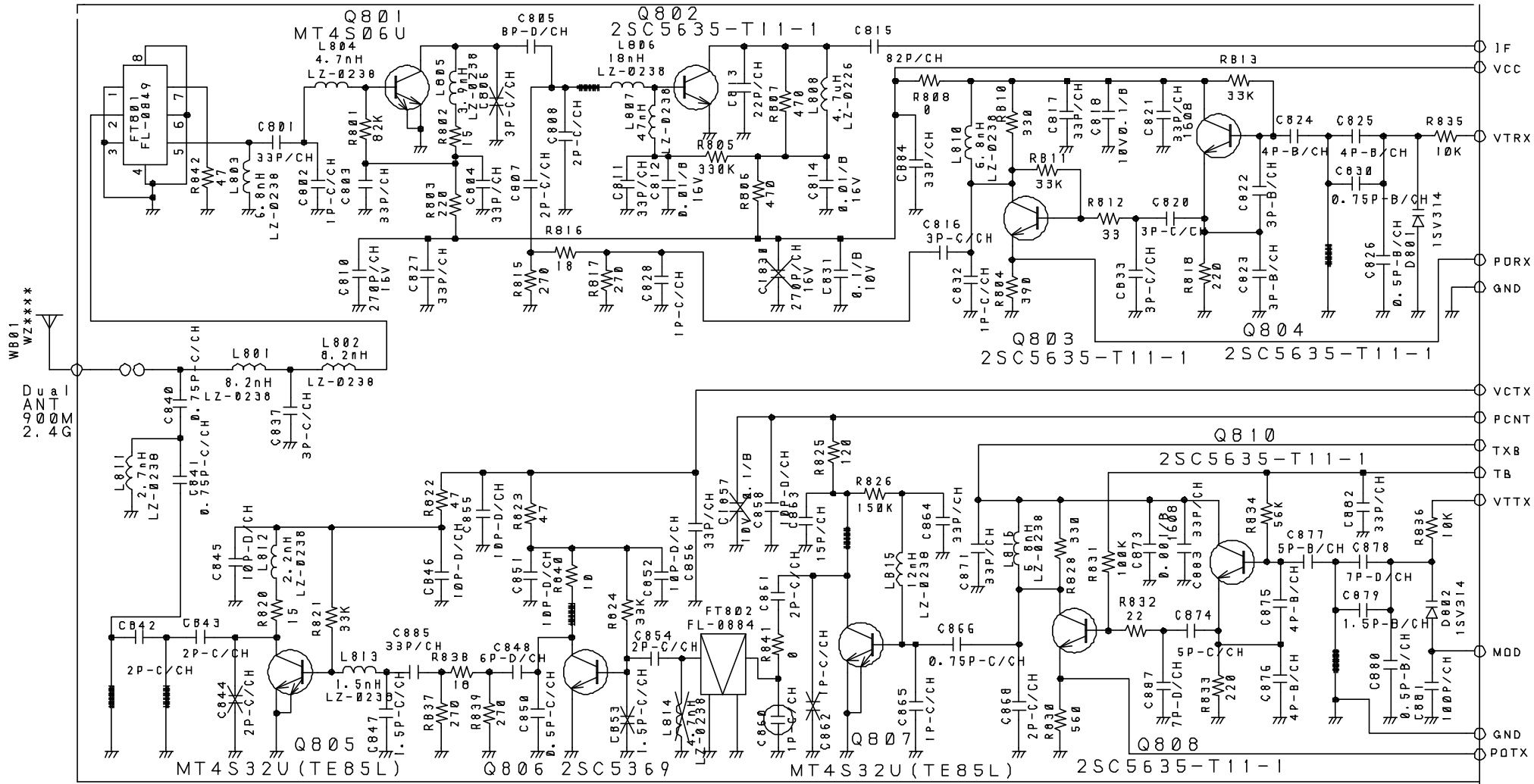




- NOTES:
1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED. (K=KILO OHM, M=MEG OHM)
 2. RESISTOR WATTAGES ARE [1/6W] UNLESS OTHERWISE NOTED
 3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P=PICO-MICRO FARAD)
 4. CHIP PARTS ARE NOT SPECIFIED IN THIS DRAWING PLEASE REFER TO THE PARTS LIST FOR THE CHIP PARTS.
 5. CHIP CAPACITORS TYPE ARE [1608] UNLESS OTHERWISE NOTED

DESIGN	DRAWN BY	UNION NO.	MODEL NO.
01/87/3Q	J. KATO	UC358ZH	E X 1 2 2 4
NKZT	J. KATO	TITLE	
CHECK BY	APPRO BY	BASE SCHEMATIC DIAGRAM	
		DRAWING No	
		B1/11/13 W/S	
REV No		UNION CORP.	



NOTES:

1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED. (K=KILO OHM, M=MEG OHM)
2. RESISTOR WATTAGES ARE [1/16W (1005)] UNLESS OTHERWISE NOTED.
3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P=MICRO-MICRO FARAD)
4. CHIP PARTS ARE NOT SPECIFIED IN THIS DRAWING PLEASE REFER TO THE PARTS LIST FOR THE CHIP PARTS.
5. CHIP CAPACITORS TYPE ARE [1005] UNLESS OTHERWISE NOTED.

DESIGN	DRAWN BY	UNIDEN No.	MODEL No.
May/14/01	01/11/09	ANALOG	2.4G + 900M
YU1	SUWA	TITLE BASE RF SCHEMATIC DIAGRAM	
CHECK BY	APPRO BY		
		DRAWING No.	
REV. No.	○×追加 Rev 10/02		UNIDEN CORP.

Q501 2SC2714-Y

FT51B FL-8B65

C615 RT10470KB

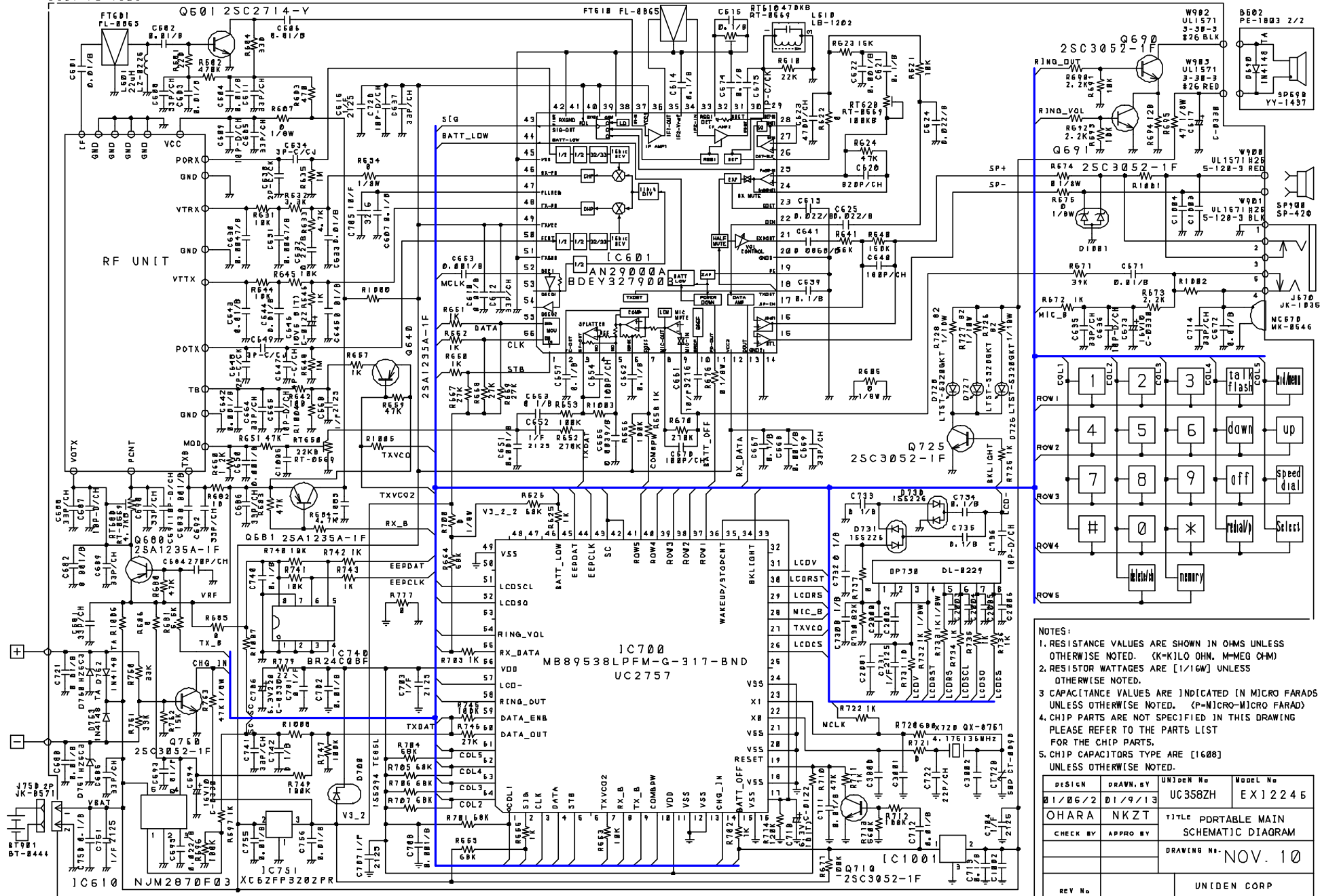
RT-8569

LE1B

LB-1202

B602

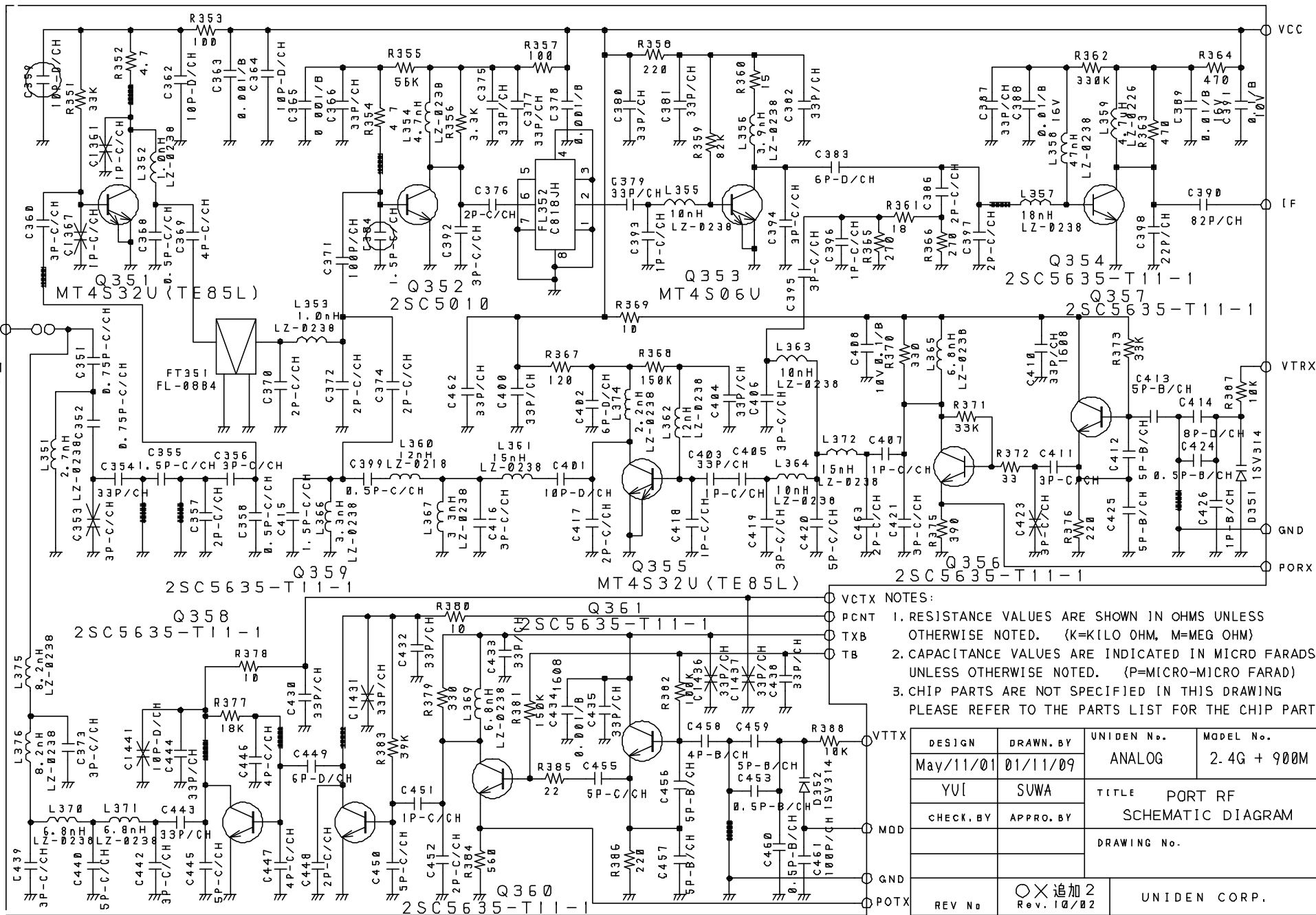
PE-1B03 2/2



NOTES:

1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED. (K-KILO OHM, M-MEG OHM)
2. RESISTOR WATTAGES ARE [1/16W] UNLESS OTHERWISE NOTED.
3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P-MICRO-MICRO FARAD)
4. CHIP PARTS ARE NOT SPECIFIED IN THIS DRAWING PLEASE REFER TO THE PARTS LIST FOR THE CHIP PARTS.
5. CHIP CAPACITORS TYPE ARE [1608] UNLESS OTHERWISE NOTED.

DESIGN	DRAWN BY	UNIDEN No	MODEL No
B1/B6/2	B1/9/13	UC358ZH	EX12245
OHARA NKZT		TITLE PORTABLE MAIN SCHEMATIC DIAGRAM	
CHECK BY	APPRO BY	DRAWING No.	NOV. 10
REV No	UNIDEN CORP		



▷ VCTX NOTES:

1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED. {K=KILO OHM, M=MEG OHM}
2. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. {P=MICRO-MICRO FARAD}
3. CHIP PARTS ARE NOT SPECIFIED IN THIS DRAWING PLEASE REFER TO THE PARTS LIST FOR THE CHIP PARTS.

X	DESIGN	DRAWN BY	UNIDEN No.	MODEL No.
	May/11/01	01/11/09	ANALOG	2.4G + 900M
D	YU[	SUWA	TITLE PORT RF	
	CHECK BY	APPRO. BY	SCHEMATIC DIAGRAM	
			DRAWING No.	
D				
X	REV No	○×追加 2 Rev. 10/02	UNIDEN CORP.	